

# GP1S562

## Compact Photointerrupter with Holders

## ■ Features

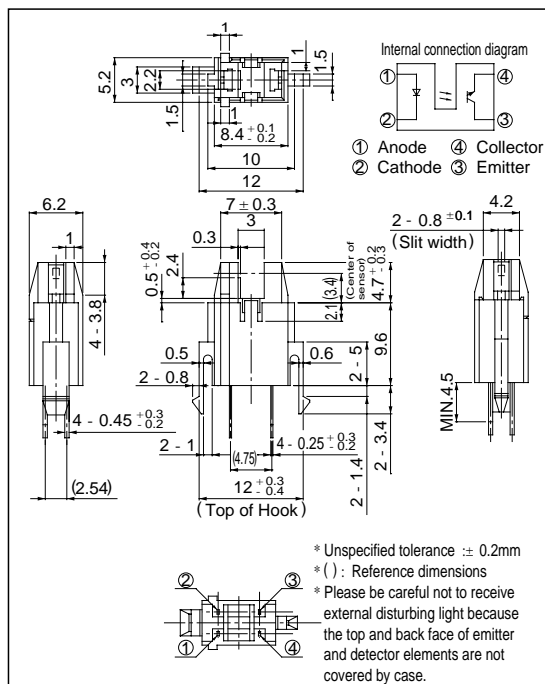
1. Compact package
2. With a spacer
3. With a hook for temporary installation to PWB

## ■ Applications

1. Floppy disk drivers
2. VCRs

## ■ Outline Dimensions

( Unit : mm)



### ■ Absolute Maximum Ratings

(Ta = 25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	*1Peak forward current	$I_{FM}$	1	A
	Reverse voltage	$V_R$	6	V
	Power dissipation	P	75	mW
Output	Collecotr-emitter voltage	$V_{CEO}$	35	V
	Emitter-collector voltage	$V_{ECO}$	6	V
	Collector current	$I_C$	20	mA
	Collector power dissipation	$P_C$	75	mW
Operating temperature		$T_{opr}$	- 25 to + 85	°C
Storage temperature		$T_{sg}$	- 40 to + 100	°C
*2Soldering temperature		$T_{sol}$	260	°C

\*1 Pulse width $\leq$ 100 $\mu$ s, Duty ratio: 0.01

\*2 For 5 seconds

■ Electro-optical Characteristics

(Ta= 25°C)

Parameter		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	$V_F$	$I_F = 20\text{mA}$	-	1.25	1.4	V
	Peak forward voltage	$V_{FM}$	$I_{FM} = 0.5\text{A}$	-	3	4	V
	Reverse current	$I_R$	$V_R = 3\text{V}$	-	-	10	$\mu\text{A}$
Output	Collector dark current	$I_{CEO}$	$V_{CE} = 20\text{V}$	-	1	100	nA
Transfer characteristics	Collector current	$I_C$	$V_{CE} = 5\text{V}, I_F = 20\text{mA}$	1.4	-	8.5	mA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F = 40\text{mA}, I_C = 1.4\text{mA}$	-	-	0.4	V
	Response time	Rise time	$V_{CE} = 2\text{V}, I_C = 2\text{mA}$	-	3	15	$\mu\text{s}$
		Fall time		-	4	20	$\mu\text{s}$

Fig. 1 Forward Current vs. Ambient Temperature

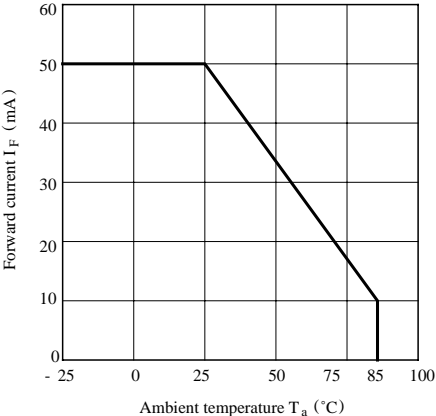


Fig. 2 Collector Power Dissipation vs. Ambient Temperature

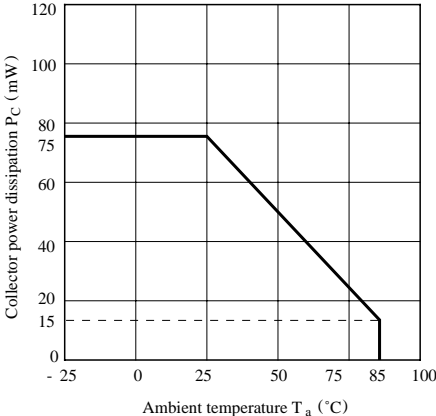


Fig. 3 Peak Forward Current vs. Duty Ratio

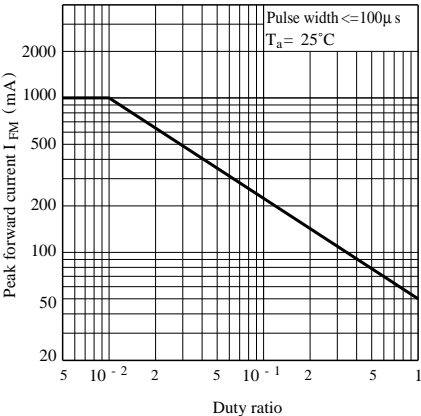


Fig. 4 Forward Current vs. Forward Voltage

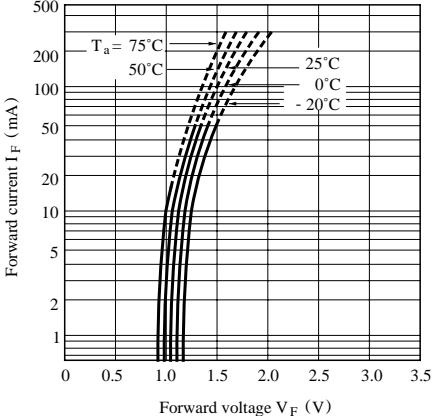


Fig. 5 Collector Current vs. Forward Current

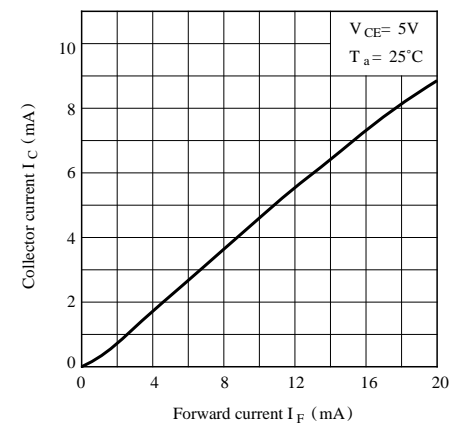


Fig. 6 Collector Current vs. Collector-emitter Voltage

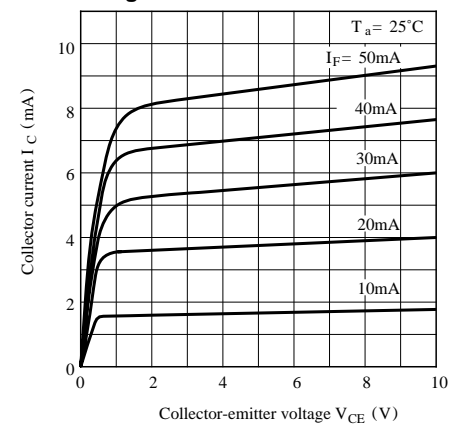


Fig. 7 Collector Current vs. Ambient Temperature

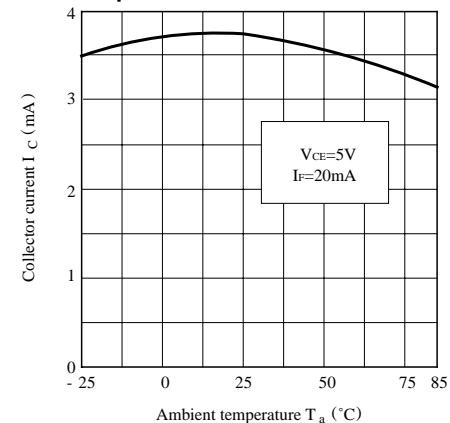


Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature

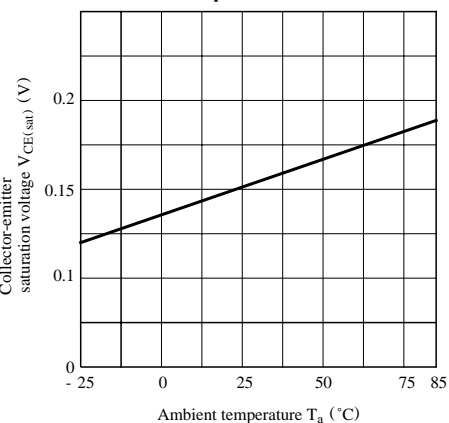
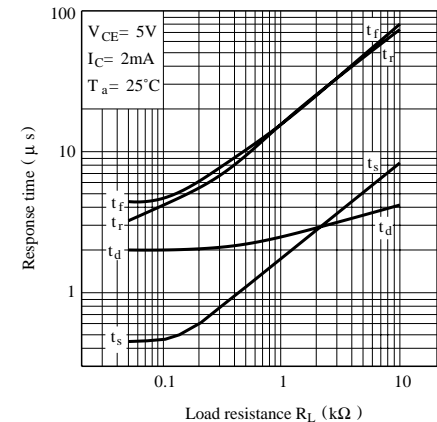


Fig. 9 Response Time vs. Load Resistance



Test Circuit for Response Time

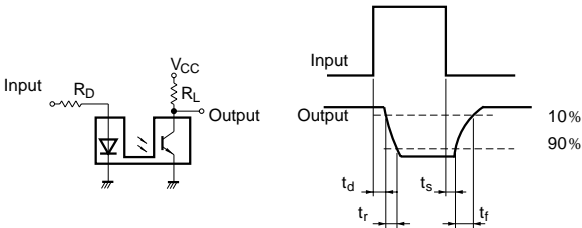


Fig.10 Frequency Response

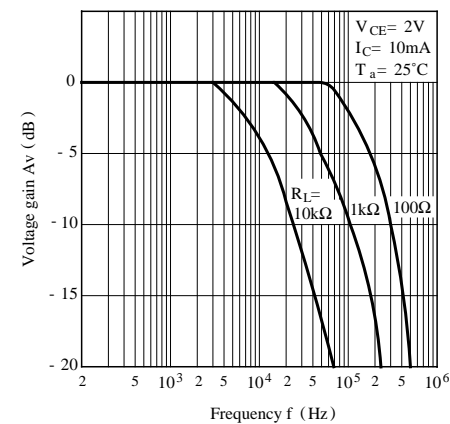
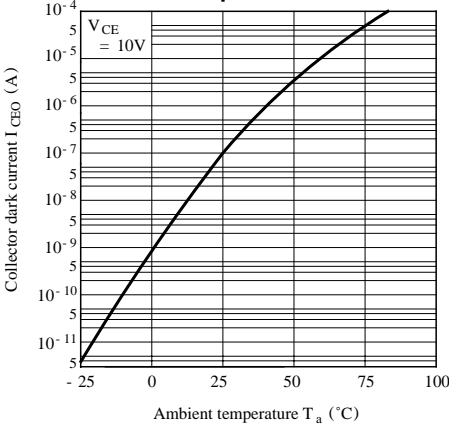


Fig.11 Collector Dark Current vs. Ambient Temperature



- Please refer to the chapter “Precautions for Use”.

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